

# Features

- Fast Switching
- Improved dv/dt Capability
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 62.5°C/W Junction to Ambient
- Thermal Resistance: 5°C/W Junction to Case<sup>(Note 1)</sup>

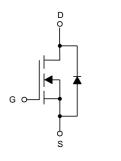
Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	800	V
Gate-Source Volltage	V <sub>GS</sub>	±30	V
Continuous Drain Current	I <sub>D</sub>	5	Α
Pulsed Drain Current (Note1)	I <sub>DM</sub>	20	А
Single Pulse Avalanche Energy (Note 2)	E <sub>AS</sub>	151	mJ
Avalanche Current (Note1)	I <sub>AS</sub>	5.5	A
Repetitive Avalanche Energy (Note1)	E <sub>AR</sub>	90	mJ
Total Power Dissipation	P <sub>D</sub>	25	W

Note: 1.Repetitive Rating: Pulse Width Limited by Maximum Junction

## Temperature.

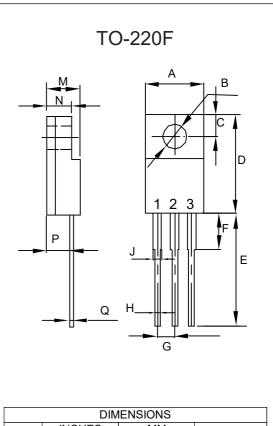
2.I<sub>AS</sub>=3A, V<sub>DD</sub>=50V, R<sub>G</sub>=25  $\Omega$ , Starting T<sub>J</sub>=25°C.

## **Internal Structure**





# N-CHANNEL MOSFET



	INCHES		DIMENSIONS INCHES MM		NOTE
DIM	MIN	MAX	MIN	MAX	NOTE
А	0.392	0.421	9.96	10.70	
В	0.1	38	3.5	50	Φ
С	0.106		2.7	70	TYP.
D	0.567	0.642	14.40	16.30	
Е	0.5	20	13.	20	TYP.
F		0.177		4.50	
G	0.1	00	2.5	54	TYP.
Н	0.020	0.035	0.50	0.90	
J	0.043	0.053	1.10	1.35	
М	0.169	0.201	4.30	5.10	
Ν		0.140		3.56	
Р	0.083	0.126	2.10	3.20	
Q	0.020	0.032	0.50	0.80	



## Electrical Characteristics @ 25°C (Unless Otherwise Specified)

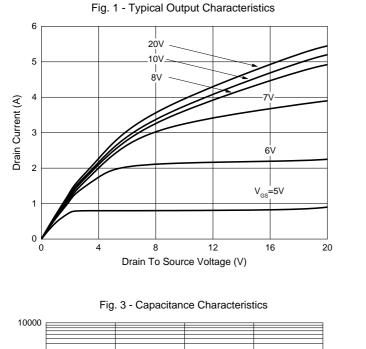
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static Characteristics	1			1	1	
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	800			V
Gate-Source Leakage Current	I <sub>GSS</sub>	$V_{DS}$ =0V, $V_{GS}$ =±30V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =800V, V <sub>GS</sub> =0V			1	
		V <sub>DS</sub> =640V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	100		100	- μΑ
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	3		4	V
Drain-Source On-Resistance <sup>(Note 3)</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =2.5A		2.3	2.8	Ω
Dynamic Characteristics <sup>(Note 4)</sup>						
Input Capacitance	C <sub>iss</sub>			667		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V,f=1MHz		77		
Reverse Transfer Capacitance	C <sub>rss</sub>			14		
Total Gate Charge	Qg			27		nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DD}$ =640V, $V_{GS}$ =10V, $I_{D}$ =5A		3.5		
Gate-Drain Charge	Q <sub>gd</sub>			13		
Turn-On Delay Time	t <sub>d(on)</sub>			37		
Turn-On Rise Time	t <sub>r</sub>			15		
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = 400V, I_{D} = 5A, R_{G} = 25\Omega$		144		- ns
Turn-Off Fall Time	t <sub>f</sub>			41		
Drain-Source Body Diode Cha	racteristi	cs	·			
Continuous Body Diode Current	I <sub>S</sub>	T _25°C			5	Δ
Pulsed Diode Forward Current	I <sub>SM</sub>	T <sub>C</sub> =25°C			20	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>SD</sub> =2.5A, V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time	t <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =5A,di <sub>F</sub> /dt=100A/µs		1099		ns
Reverse Recovery Charge	Q <sub>rr</sub>	$v_{GS}$ – $vv$ , $i_{S}$ – $3\pi$ , $u_{F}/u_{C}$ – $100\pi/\mu S$		3.2		μC

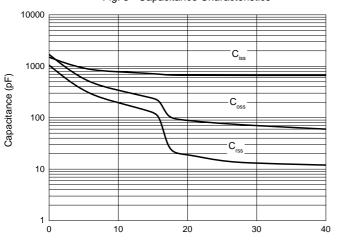
Note 3. Pulse Test : Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  1%.

4. Guaranteed by Design, Not Subject to Production Testing.

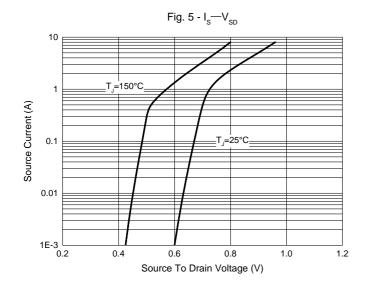


# **Curve Characteristics**









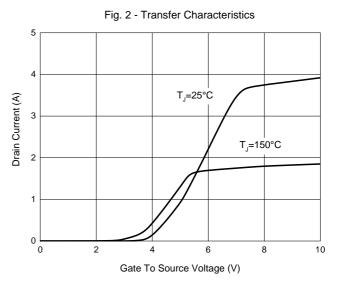
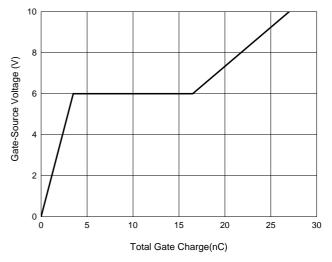
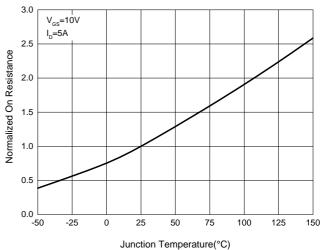


Fig. 4 - Gate Charge Characteristics









# **Ordering Information**

Device	Packing	
Part Number-BP	Bulk: 1Kpcs/Box	

Note : Adding "-HF" Suffix for Halogen Free, eg. Part Number-BP-HF

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